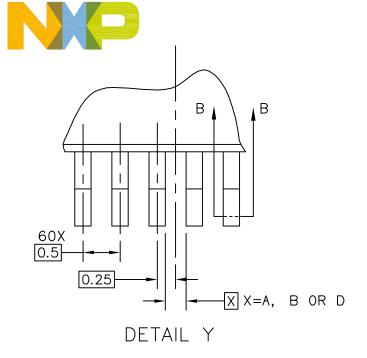
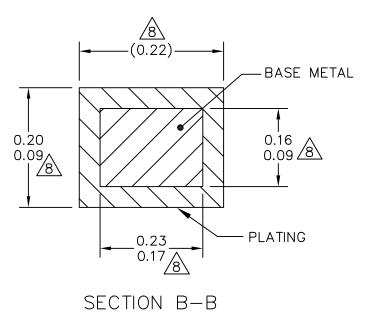
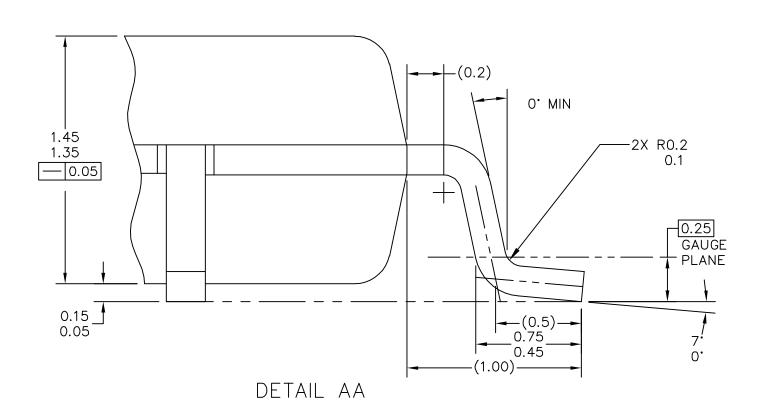


NXP SEMICONDUCTORS N. V. ALL RIGHTS RESERVED	MECHANICAL OU	TLINE	PRINT VERSION NOT T	O SCALE
LQFP, 10 X 10 X 1.4 PKG, 0.5 PITCH, 64LD		DOCUMEN	NT NO: 98ASS23234W	REV: G
		STANDARD: JEDEC MS-026 BCD		
10 / 10 / 1.11 1 (0, 0.0	111011, 0120	S0T1699	9–1 25	JAN 2016







NXP SEMICONDUCTORS N.V. ALL RIGHTS RESERVED	MECHANICAL OU	TLINE	PRINT VERSION NOT TO SCALE	
TITLE:		DOCUMEN	NT NO: 98ASS23234W REV: G	
LQFP, 10 X 10 X 1.4 PKG, 0.5	PITCH 64LD	STANDARD: JEDEC MS-026 BCD		
		S0T1699	9-1 25 JAN 2016	



NOTES:

- 1. DIMENSIONS ARE IN MILLIMETERS.
- 2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- $\stackrel{\textstyle o}{ ext{3}}$ datums a, b and d to be determined at datum plane H.
- A DIMENSIONS TO BE DETERMINED AT SEATING PLANE C.
- THIS DIMENSION DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL NOT CAUSE THE LEAD WIDTH TO EXCEED THE UPPER LIMIT BY MORE THAN 0.08 MM AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSION AND ADJACENT LEAD SHALL NOT BE LESS THAN 0.07 MM.
- THIS DIMENSION DOES NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25 MM PER SIDE. THIS DIMENSION IS MAXIMUM PLASTIC BODY SIZE DIMENSION INCLUDING MOLD MISMATCH.
- A EXACT SHAPE OF EACH CORNER IS OPTIONAL.
- THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.1 MM AND 0.25 MM FROM THE LEAD TIP.

NXP SEMICONDUCTORS N. V. ALL RIGHTS RESERVED	MECHANICAL OUTLINE		PRINT VERSION NOT TO SCALE		
TITLE:		DOCUMEN	NT NO: 98ASS23234W	REV: G	
LQFP, 10 X 10 X 1.4 PKG, 0.5	STANDARD: JEDEC MS-026 BCD				
	111011, 0120	S0T1699	9-1	25 JAN 2016	

单击下面可查看定价,库存,交付和生命周期等信息

>>NXP Semiconductors(恩智浦)